IEEE 1687-2005 1.2 References
22.1 - 22.12

Components marked 'DNP' should not be populated.
Assembly Variant: 001

PCB Viewed from Top Side
Board #: XXXXX
Rev: 002
Svn Rev: Not In Version Control

Ignore ->

Plot Name = Top Assembly Drawing
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COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

COMPONENT MARKED 'DNP' SHOULD NOT BE POPULATED.
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